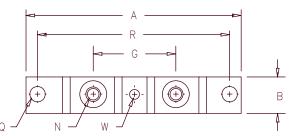
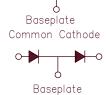
# Schottky PowerMod











D=Doubler Notes: Baseplate: Nickel plated

copper

Dim. Inches		Millimeters		
Min.	Max.	Min.	Max.	Notes
C E 0.120 F 0.490	0.510 75 BSC	12.45	17.28 3.30 12.95	
N Q 0.275 R 3.7 U 0.600 V 0.312	0.290 150 BSC	6.99 80.0 15.24 7.92		1/4-20 Dia.

Microsemi	Working Peak	Repetitive Peak
Catalog Number	Reverse Voltage	Reverse Voltage
CPT60135*	35V	35V
CPT60140*	40V	40V
CPT60145*	45V	45V
*Add Suffix	A for Common Ar	node, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 600 Amperes/35 to 45 Volts
- 150°C Junction Temperature
- Reverse Energy Tested
- Low Forward Voltage
- ROHS Compliant

### Electrical Characteristics

F(AV) 600 Amps Average forward current per pkg Average forward current per leg Maximum surge current per leg Maximum repetitive reverse current per leg |R(OV) 2 Amps Max peak forward voltage per leg |VFM 0.55 Vol Max peak forward voltage per leg  $V_{FM}$ Max peak forward voltage per leg <sup>I</sup>RM Max peak reverse current per leg Max peak reverse current per leg <sup>I</sup>RM Typical junction capacitance per leg

F(AV) 300 Amps IFSM 6000 Amps 0.55 Volts 0.43 Volts 3.0 A 21 mA  $C_{\mathsf{J}}$ 15000 pF

 $^{T}C$  = 94°C, Square wave,  $^{R}\Theta JC$  = 0.12°C/W  $^{T}C$  = 94°C, Square wave,  $^{R}\Theta JC$  = 0.21°C/W 8.3ms, half sine,  $TJ = 175^{\circ}C$  $f = 1 \text{ KHZ}, 25^{\circ}\text{C}, 1 \mu\text{sec}$  square wave  $|FM| = 300 \text{A:} \text{TJ} = 25^{\circ}\text{C}$ TFM = 300A:TJ = 150°C VRRM,TJ = 125°C\* VRRM,TJ = 25°C

 $V_R = 5.0V, T_C = 25^{\circ}C$ 

\*Pulse test: Pulse width 300 µsec, Duty cycle 2%

### Thermal and Mechanical Characteristics

Storage temp range Operating junction temp range Max thermal resistance per leg Max thermal resistance per pkg Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

TSTG ΤJ R OJC ROJC Recs

-55℃ to 150℃ -55℃ to 150℃ 0.21°C/W Junction to case 0.12°C/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



# CPT60135 - CPT60145

Figure 1 Typical Forward Characteristics — Per Leg

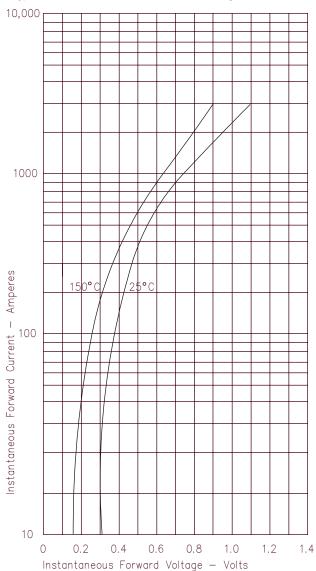


Figure 2 Typical Reverse Characteristics — Per Leg

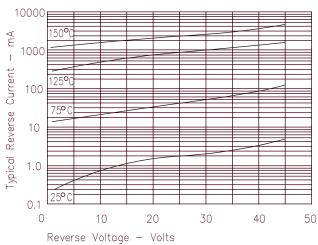


Figure 3
Typical Junction Capacitance — Per Leg

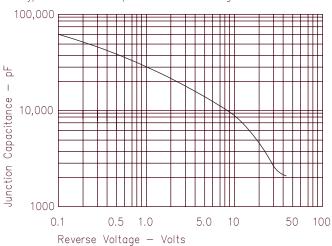


Figure 4
Forward Current Derating — Per Leg

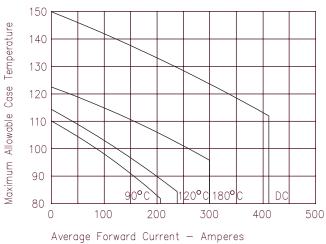
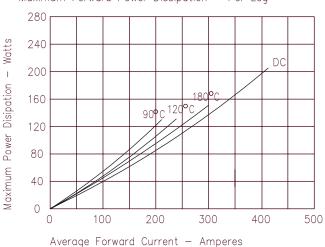


Figure 5
Maximum Forward Power Dissipation — Per Leg





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